



20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = +25°C
201/	$35m\Omega @ V_{GS} = -4.5V$	-6.0A
-20V	$45 \text{m}\Omega$ @ $V_{GS} = -2.5V$	-5.2A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Motor Control
- Power management functions
- Analog Switch

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- ESD protected Up To 3KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)

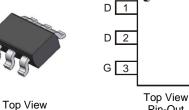
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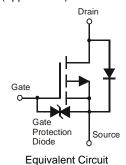
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TSOT26





Ordering Information (Note 5)

Part Number	Case	Packaging		
DMP2035UVTQ-7	TSOT26	3,000/Tape & Reel		
DMP2035UVTQ-13	TSOT26	10,000/Tape & Reel		

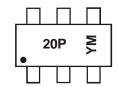
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Pin-Out

- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q10x qualified and are PPAP capable. Automotive, AEC-Q10x and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



20P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α	-	В	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMP2035UVTQ Document number: DS37400 Rev. 2 - 2



Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	-20	V	
Gate-Source Voltage		V _{GSS}	±12	V	
Operitor and Decision Comment (New 727)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-6.0 -4.8	А
Continuous Drain Current (Note 7) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-7.2 -5.7	А
Continuous Drain Current (Note 7) // 2.5\/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	-5.2 -4.1	А
Continuous Drain Current (Note 7) V _{GS} = -2.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-6.2 -4.9	А
Maximum Continuous Body Diode Forward Current	(Note 7)	Is	-2.0	Α	
Pulsed Drain Current (10µs pulse, duty cycle = 1%))	I _{DM}	-24	А	

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)		P_{D}	1.2	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	0	106	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	74	C/VV	
Total Power Dissipation (Note 7)		P_{D}	2.0	W	
Thermal Desistance, Junction to Ambient (Note 7)	Steady State	Б	65		
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{\theta JA}$	46	°C/W	
Thermal Resistance, Junction to Case (Note 7)	Steady State	$R_{ heta JC}$	11.8		
Operating and Storage Temperature Range		$T_{J_{I}}T_{STG}$	-55 to 150	°C	

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	1	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	$V_{GS(th)}$	-0.4	-0.7	-1.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
Gate Threshold Voltage Temperature Coefficient	$_{\triangle}V_{GS(th)}/_{\triangle}T_{J}$	_	2.5		mV/°C	$I_D = -250\mu A$, Referenced to +25°C		
		_	23	35		$V_{GS} = -4.5V$, $I_{D} = -4.0A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	30	45	mΩ	$V_{GS} = -2.5V$, $I_{D} = -4.0A$		
		_	41	62		$V_{GS} = -1.8V, I_D = -2.0A$		
Forward Transfer Admittance	Y _{fs}	_	18	_	S	$V_{DS} = -5V, I_{D} = -5.5A$		
Diode Forward Voltage (Note 7)	V _{SD}	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	Ciss	_	1610	2400		V 40V V 0V		
Output Capacitance	Coss	_	157	210	pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	145	200		1 – 1.000112		
Gate Resistance	R_{G}	_	9.4	14.1	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$		
Total Gate Charge	Q_{g}	_	15.4	23.1		\/ 40\/\\/ 45\/		
Gate-Source Charge	Q_{gs}	_	2.5	1	nC	$V_{DS} = -10V, V_{GS} = -4.5V$ $I_{D} = -4A$		
Gate-Drain Charge	Q_{gd}	_	3.3			ID = -4A		
Turn-On Delay Time	t _{D(on)}	_	17	33				
Turn-On Rise Time	t _r	_	12	19		$V_{GS} = -4.5V$, $V_{DS} = -10V$, $R_G = 6\Omega$		
Turn-Off Delay Time	t _{D(off)}	_	94	150	ns	$I_D = -1A$, $R_L = 10\Omega$		
Turn-Off Fall Time	t _f	_	42	64				
Reverse Recovery Time	t _{rr}	_	14	25	ns	1 4 5 A di/dt 100 \ / \ \ C		
Reverse Recovery Charge	Qrr		4	8	nC	_F =-4.5A, di/dt=100A/µS		

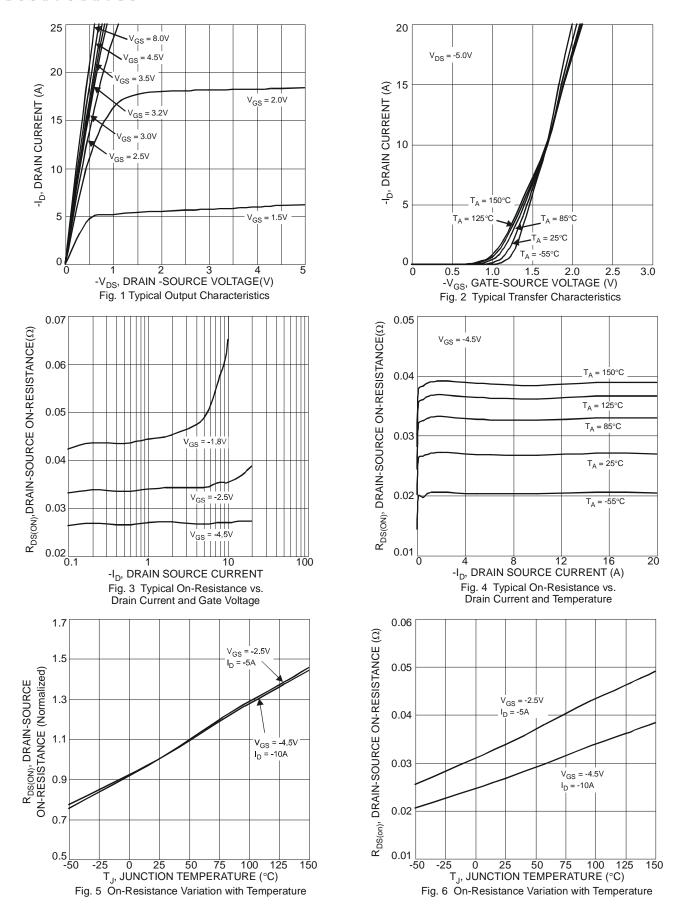
6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

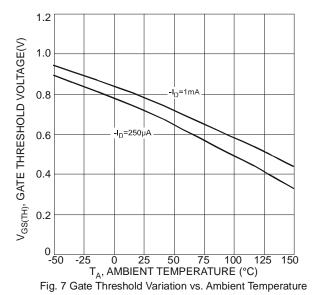
8. Short duration pulse test used to minimize self-heating effect.

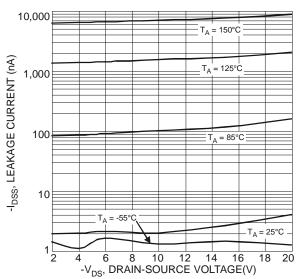
9. Guaranteed by design. Not subject to product testing.

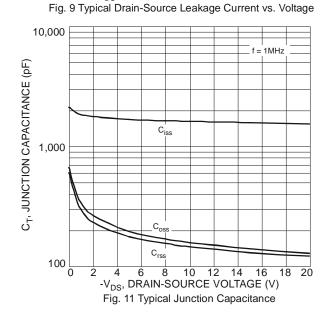


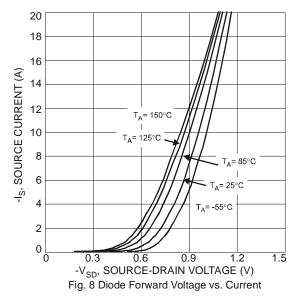












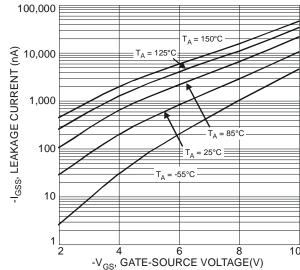
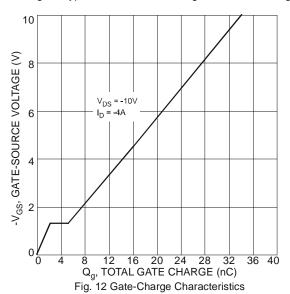
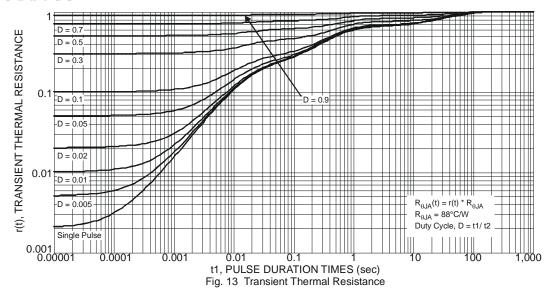


Fig. 10 Typical Gate-Source Leakage Current vs. Voltage

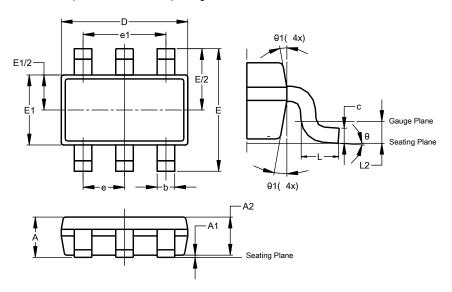






Package Outline Dimensions

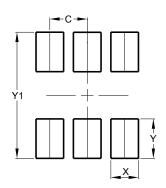
Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26								
Dim	Min	Max	Тур					
Α	-	1.00	-					
A1	0.010	0.100	_					
A2	0.840	0.900	_					
D	2.800	3.000	2.900					
E	2	2.800 BS	С					
E1	1.500	1.700	1.600					
b	0.300 0.450		-					
С	0.120	0.200	_					
е	0.950 BSC							
e1	1	.900 BS	С					
L	0.30 0.50 -		-					
L2	0.250 BSC							
θ	0° 8°		4°					
θ1	4°	12°	-					
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Υ	1.000
Y1	3.199



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